

Attorney's Docket No SEI 10016

As a below n	amed inventor, I h	ereby declare tha	t:				
This declarat	ion is of the follow	ng type:					
[ ] origi	nal [ ] supplem	ental					
	onal stage of PCT ional [ ] o	continuation	[ ] continua	ition-in-part			
My residence	, post office addre	ss and citizenship	are as stated	next to my name,			
I believe I am inventor (if pl sought on the	the original, first a	and sole inventor ed below) of the s	(if only one na subject matter	me is listed below) or which is claimed and	an ongina for which	il, first an a patent i	id joint is
the specificati	on of which	,	٠				
[]	is attached hereto						
[X]			erial Number	10/030525 (if ap	policable).	and,	
[X]	was filed on						
	as PCT Interr was amended	national Application I under PCT Artic	on Number le 19 on	PCT/JP00/02914	a	nd, _ (if appl	icable).
I hereby state the claims, as	that I have review amended by any a	ed and understan	d the contents ed to above.	of the above-identifie	d specific	ation, inc	gnibuk
i acknowledge Federal Regul	the duty to disclos ations, Section 1.5	e information wh	ich is material	to patentability as de	fined in Tit	tle 37, Co	ode of
designated at inchecking the b	for patent or invent least one country o	ors certificate, of ther than the Uni plication for pater	<sup>-</sup> 365(a) of any ted States, list it or inventor's	e, Section 119(a)-(d) o PCT International ap ed below and have al œrtificate, or PCT In y is claimed.	plication v	vhich	hv
	PRIOR FOREIGN	APPLICATIONS	BENEFIT CL	AIMED UNDER 35 U	SC §119(a	1)	
Application Nu		Country		Date of Filing (Day/Month/Year)	Pri	ority Clai	
P1999-12	7688	Japan	<u> </u>	07 / May / 1999		ΣΥes	No
				· · · · · · · · · · · · · · · · · · ·	<del></del>	∐Yes	No



I hereby claim the benefit under Title 35, United States Code, Section 119(e) of any United States provisional application(s) listed below.

#### PRIOR U.S. PROVISIONAL APPLICATIONS, BENEFIT CLAIMED UNDER 35 USC §119(e)

(Application No)	(Filing Date)	(Application No.)	(Filing Date)
(Application No.)	(Filing Date)	(Application No.)	(Filing Date)

I hereby claim the benefit of Title 35, United States Code Section 120 of any United States application(s), or 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of Title 35, United States Code Section 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application:

# PRIOR U.S. APPLICATIONS OR PCT INTERNATIONAL APPLICATIONS DESIGNATING THE U.S., BENEFIT CLAIMED UNDER 35 USC §120

(Application No.)	(Filing Date)	(Status: Patented, Pending, Abandoned)
(Application No.)	(Filing Date)	(Status: Patented, Pending, Abandoned)

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith (list name and registration number or Customer Number)

Raymond R. Moser, Jr.
B. Todd Patterson
Keith M. Tackett
Douglas H. Elliot
W. Bruce Patterson
Phong D. Nguyen

Registration No. 34,682 Registration No. 37,906 Registration No. 32,008 Registration No. 32,982 Registration No. 34,102 Registration No. 43,833

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1	Full Name of sole or first im  Naoki TA				
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	Second inventor's signature			Date	
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ř	Full Name third joint inventor,	if now			
1	Yuji TAK			•	
w l	Third inventor's signature	10.01		Dete	
1	يسب			Date	
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UL	Seayoul P	•			
	Fourth inventor's signature			Date .	
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ŀ	Cilizenshin		<del>                                      </del>		
- 1	Korea (South)		1	•	
T	Post office address				
	c/o Applied Mater	ials Japan, Inc.			
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1	Narita-shi Chil	 oa 286-8516 Japan			



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Nanta-oni, Oniba 200-03 to Dapan		
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MOSER PATTERSON &

16

Attorney's Docket No. SEI/0016

As a below n	amed invento	r, I hereby declare ti	nat:		
This declarat	tion is of the fo	ollowing type:			
[ ] origi	inal [ ] sup	plemental			
•	onal stage of F sional	PCT [ ] continuation	. [ ] continu	ation-in-part	
My residence	e, post office a	ddress and citizensl	nip are as state	d next to my name.	
inventor (if pl sought on the	lural names ar e invention en	e listed below) of the	e subject matte	r which is claimed and fo	an onginal, first and joint or which a patent is
the specificat	ion of which		•		
[]	is attached h	ereto			
[x]	as Unite		Serial Number	10/030525 (if app	
[X]	was filed on as PCT was am	May 2, 2 International Applica ended under PCT Ar	000 ation Number _ ticle 19 on	PCT/JP00/02914	and, (if applicable)
I hereby state the claims, as	that I have re amended by	viewed and underst any amendment ref	and the content erred to above	s of the above-identified	d specification, including
l acknowledge Federal Regu	e the duty to d lations, Section	isclose information v on 1.56.	which is materia	al to patentability as defi	ned in Title 37, Code of
application(s) designated at checking the l	for patent or i least one cou box, any foreig	nventor's certificate, ntry other than the L	or 365(a) of an Inited States, litent or inventor	de, Section 119(a)-(d) or ny PCT International app sted below and have als 's certificate, or PCT Int rity is claimed.	olication which to identified below, by
	PRIOR FOR	EIGN APPLICATION	IS, BENEFIT C	LAIMED UNDER 35 US	C §119(a)
Application N	lumber	Country		Date of Filing (Day/Month/Year)	Priority Claimed Under 35 USC 119
P1999-12	27688	Japan		07 / May / 1999	XYes ∏No
					—— ⊓ tes Πνό

I hereby claim the benefit under Title 35, United States Code, Section 119(e) of any United States provisional application(s) listed below.

#### PRIOR U.S. PROVISIONAL APPLICATIONS, BENEFIT CLAIMED UNDER 35 USC §119(e)

(Application No.)	(Filing Date)	(Application No.)	(Filing Date)
(Application No.)	(Filing Date)	(Application No.)	(Filing Date)

I hereby claim the benefit of Title 35, United States Code Section 120 of any United States application(s), or 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of Title 35, United States Code Section 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application:

# PRIOR U.S. APPLICATIONS OR PCT INTERNATIONAL APPLICATIONS DESIGNATING THE U.S., BENEFIT CLAIMED UNDER 35 USC §120

(Application No.)	(Filing Date)	(Status: Patented. Pending, Abandoned)
(Application No.)	(Filing Date)	(Status: Patented, Pending, Abandoned)

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith (list name and registration number or Customer Number)

Raymond R. Moser, Jr.
B. Todd Patterson
Keith M. Tackett
Douglas H. Elliot
W. Bruce Patterson
Phong D. Nguyen
Registration No. 34,682
Registration No. 37,906
Registration No. 32,008
Registration No. 32,982
Registration No. 34,102
Registration No. 34,833

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Direct Telephone Calls to: W. Bruce Patterson at telephone number 713-623-4844

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Full Name s	econd joint inventor, if any	
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	Yuji TAKAOKA	
Third invento	or's signature	Date
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Full Name fo	urth Joint Inventor, if any	
	Seayoul PARK	
Fourth invent	tor's signature 井 サ あ	July 8, 2002
Residence	Markackik Ohilanokapanok Blk 27, Hazel	Park Terrace #09-03, Singapore 678949
Citizenship	Korea (South)	
Post office as	idress et <del>a kaptied biakeisko kapano kaso</del> c	As in a strict the second and a second
<b>x</b>	14-95-81176/2001/c 1781787-9.07(158-7286-8878-7087920)	c/o Applied Materials South-East Asia Pte. Ltd 200 Pandan Loop #08-01/04, Pantech 21 Computer Center, Singapore 128388



			·
Full Name f	ifth joint inventor, if any Yasushi TAKAKURA		
Fifth invento	or's signature	Date	×.
Residence	Narita-shi, Chiba, Japan	The second secon	10-14
Citizenship	Japan .		
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	clo Applied Materials Japan, Inc.		
	14-3, Shinizumi, Narita-shi, Chiba 286-8516 Japan		
Full Name si	ixth Joint Inventor, If any		
	Hideyuki YAMAUCHI		
Shith Invento	n's signature	Date	

Shith Inventor's signature

Residence
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14-3, Shinizumi,
Narita-shi, Chiba 286-8516 Japan





Attorney's Docket No SFI/80/6

As a below na	As a below named inventor. I hereby declare that:						
This declaration is of the following type:							
[ ] origin	ial [ ] suppleme	ental					
	nal stage of PCT onal []c	ontinuation	[ ] continua	ation-in-part			
My residence,	post office addres	s and citizensh	ip are as stated	next to my nam	е		
I believe I am the original, first and sole inventor (if only one name is listed below) or an original first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled  METHOD OF MANUFACTURING SEMICONDUCTOR DEVEICE					d joint s		
the specificatio	on of which						
{ ] i	is attached hereto				- 1.		
(X) v		tes Application	Serial Number	10/0305		and ble)	٠
[X] v		ational Applica	tion Number	PCT/JP00/0			cable).
hereby state the claims as a	hat I have reviewe amended by any a	ed and understa mendment refe	and the contents erred to above.	s of the above-id	entified spe	cification, incl	uding
l acknowledge i Federal Regula	the duty to disclos ations, Section 1.5	e information v 3	vhich is materia	l to patentability	as defined i	in Title 37, Co	de of
hereby claim foreign priority under Title 35, United States Code Section 119(a)-(d) or 365(b) of any foreign application(s) for patent or inventor's certificate, or 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed.							
PRIOR FOREIGN APPLICATIONS, BENEFIT CLAIMED UNDER 35 USC §119(a)							
Application Nu	mber	Country	•	Date of Filin (Day/Month/Yea	g ar)	Priority Clair Under 35 US	med C 119
P1999-127	7688	Japan		07 / May / 1	1999	X Yes	
						1 1162	INAO

I hereby claim the benefit under Title 35 United States Code. Section 119(e) of any United States provisional application(s) listed below.

#### PRIOR U.S. PROVISIONAL APPLICATIONS, BENEFIT CLAIMED UNDER 35 USC §119(e)

(Application No.)	(Filing Date)	(Application No.)	(Filing Date)
(Application No.)	(Filing Date)	(Application No.)	(Filing Date)

I hereby claim the benefit of Title 35, United States Code Section 120 of any United States application(s), or 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of Title 35, United States Code Section 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37. Code of Federal Regulations, Section 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application:

#### PRIOR U.S. APPLICATIONS OR PCT INTERNATIONAL APPLICATIONS DESIGNATING THE U.S. BENEFIT CLAIMED UNDER 35 USC §120

(Application No)	(Filing Date)	(Status Patented, Pending Abandoned)
(Application No.)	(Filing Date)	(Status: Patented Pending Abandoned)

POWER OF ATTORNEY. As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith (list name and registration number or Customer Number)

Raymond R. Moser Jr
B. Todd Patterson
Keith M. Tackett
Douglas H. Elliot
W. Bruce Patterson
Phong D Nguyen

Registration No. 34,682
Registration No. 32,908
Registration No. 32,982
Registration No. 34,102
Registration No. 43,833

Send Correspondence to:

MOSER, PATTERSON & SHERIDAN, L.L.P.

3040 POST OAK BOULEVARD SUITE 1500 HOUSTON, TEXAS 77056

Direct Telephone Calls to: W Bruce Patterson at telephone number 713-623-4844



Full Name	of sole or first inventor	•		<del></del> -
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Inventor's	signature	Date		
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Residence	Shinagawa-ku, Tokyo, Japan			
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	Rie KOGURE			
Second inv	entor's signature	Date		
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Full Name to	nire joint Inventor, if any			
	Yuji TAKAOKA			
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	7-35, Kitashinagawa 6-chome, Shinagawa-ku, Tokyo 141-0001 Japan			
Full Name fo	auth joint inventor, if any			
	Seayoul PARK			
Fourth inven	lof's slynature	Date .		
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Citizenship	Korea (South)			
Post office a	ddress do Applied Materials Japan, Inc.			
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Full Name	fifth joint inventor, if any	
]	Yasushi TAKAKURA	
Fifth inverse	or's signature 30 10 35 7	Date July 8, 2002
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Sadh Invent	or's signature	Date .
Residence	Narita-shi, Chiba, Japan	
Citizenship	Japan	
Post office a	oddress c/o Applied Materials Japan, Inc.	,
I		



Attorney's Docket No. 50EI 10016

As a below named inventor, i hereby declare that:				
This declaration is of the following type:				
[ ] original [ ] supplemental				
[X] national stage of PCT [ ] divisional [ ] continuation [ ] continuation-in-part				
My residence, post office address and citizenship are as stated next to my name,				
I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled  METHOD OF MANUFACTURING SEMICONDUCTOR DEVEICE				
he specification of which				
[ ] is attached hereto.				
[X] was filed on November 7, 2001  as United States Application Serial Number 10/030525 and, was amended on (if applicable).				
[X] was filed on May 2, 2000				
as PCT International Application Number PCT/JP00/02914 and, was amended under PCT Article 19 on (if applicable).				
nereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.				
acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56.				
hereby claim foreign priority under Title 35, United States Code, Section 119(a)-(d) or 365(b) of any foreign application(s) for patent or inventor's certificate, or 365(a) of any PCT International application which esignated at least one country other than the United States, listed below and have also identified below, by hecking the box, any foreign application for patent or inventor's certificate, or PCT International application aving a filing date before that of the application on which priority is claimed.				
PRIOR FOREIGN APPLICATIONS, BENEFIT CLAIMED UNDER 35 USC §119(a)				
Application Number Country Date of Filing Priority Claimed (Day/Month/Year) Under 35 USC 119				
P1999-127688         Japan         07 / May / 1999         X Yes         No           Yes         No				

I hereby claim the benefit under Title 35, United States Code, Section 119(e) of any United States provisional application(s) listed below.

#### PRIOR U.S. PROVISIONAL APPLICATIONS, BENEFIT CLAIMED UNDER 35 USC §119(e)

(Application No.)	(Filing Date)	(Application No.)	(Filing Date)
(Application No.)	(Filing Date)	(Application No.)	(Filing Date)

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(Application No.)	(Filing Date)	(Status: Patented, Pending, Abandoned)
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B. Todd Patterson
Keith M. Tackett
Douglas H. Elliot
W. Bruce Patterson
Phong D. Nguyen

Registration No. 34,682
Registration No. 32,008
Registration No. 32,982
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Send Correspondence to:

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Full Name	of sole or first inventor  Naoki TAMITANI		
Inventor's	- · · · · · · · · · · · · · · · · · · ·	Date ·	
, more in a	55.4.4.0	Date	
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Citizenship	Japan		
Post office	address de SONY CORPORATION		
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Full Name	second joint Inventor, if any		
	Rie KOGURE		
Second inv	entor's signature	Date	
Residence			<u> </u>
	Shinagawa-ku, Tokyo, Japan	•	
Citizenship	Japan		·
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	Yuji TAKAOKA	<u>.</u>	
Third invent	tor's signature	Oate	
		Manager of a contract of the c	
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Citizenship	Japan		
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Full Name fo	ourth joint Inventor, if any Seayoul PARK		
Fourth inven	itor's signature	Date	
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Citizenship	Korea (South)		
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Fuil Name f	fth joint inventor, if any	
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Fifth invento	r's signature	<b>O</b> ate
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Full Name si	oth joint inventor, if any	
	Hideyuki YAMAUCHI	·
Sixth invento	r's signature	Date
	Ididigiti Yanach	July 8, 2002
Residence	Narita-shi, Chiba, Japan	
Citizenship	Japan	
Post office a	ldress	ontine to the state of the stat
	c/o Applied Materials Japan, Inc.,	
	14-3, Shinizumi, Narita-shi, Chiba 286-6516 Japan	